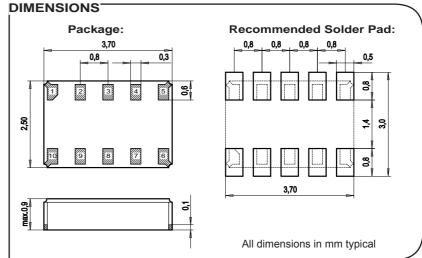


Real Time Clock Module with I²C Bus





Ultra low power consumption 130nA Xtal integrated solution.
Frequency-Offset Trimming Register Backup supply switchover circuitry Miniature SMT ceramic package Very tight frequency tolerance I²C Bus Interface (fast mode 1 MHz) Programmable Clock-output Low aging

Time keeping mode down to 1.2 V Programmable alarm, timer and interrupt functions

DESCRIPTION:

This RTC IC has been specially designed to achieve an ultra-low power consumption of typically 130nA @ V_{DD} 3.0V in time-keeping mode.

The very small SMT ceramic-package combines the 32.768 kHz crystal unit with the CMOS-based oscillator and real-time-clock circuitry.

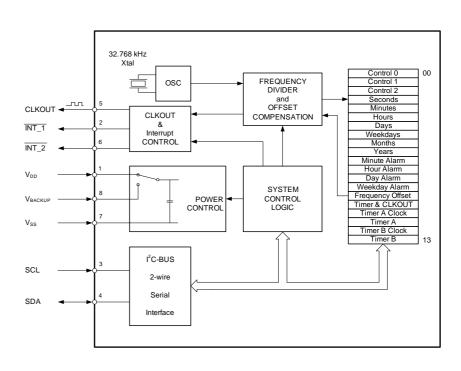
The calendar function tracks year, month, date, and day-of-the-week with built-in century and leap-year flags. The clock function tracks minute and second in 24-hour format. Programmable alarm setting, dual timer functions and integrated switch-over circuitry to backup supply voltage increase flexibility.

For pick-and-place equipment, the parts are available in 12 mm tape:

7" (178 mm) reel with 1'000 or 3'000 parts

13" (330 mm) reel with 10'000 parts

BLOCK DIAGRAM:



ELECTRICAL CHARACTERISTICS AT 25°C:

	Symbol	Condition	Min.	Тур.	Max	Unit
Supply voltage	V _{DD}	I ² C Bus Active	1.6		5.5	V
Supply voltage	V _{DD}	Power Managm.	1.8		5.5	V
Supply voltage	V_{DD}	Time keeping	1.2		5.5	V
Current consumption during access	I _{DD}	fscl=1 MHz V _{DD} 3 V		100	200	μΑ
		fscl=100 kHz V _{DD} 3 V		50	100	μΑ
Current consumption Time keeping mode	I _{DDO}	fscl=0 Hz, V _{DD} 3 V		130	180	nA
		fscl=0 Hz, V _{DD} 2 V		110	160	nA
CLKOUT frequency		Programmable	32768to1		Hz	
Frequency tolerance	ΔF/F	@ 25°C	±10 / ±20 1)		ppm	
Aging first year max.	ΔF/F	@ 25°C	± 3		ppm	
Frequency vs. temp.	ΔF/F _O	$20 \le T_0 \le 30$	-0.035 ppm/ _{°C²} (T - T ₀)² ±10%		ppm	

¹⁾ Tighter and wider frequency tolerances on request.

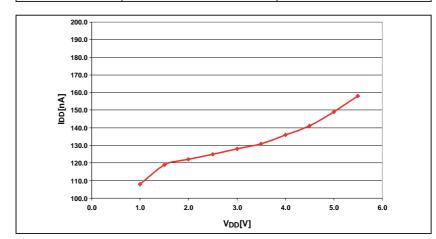
ENVIRONMENTAL CHARACTERISTICS:

		Conditions	Max. Dev.
Storage temp. range		–55 to +125°C	
TA Operating temperature range		–40 to +85°C	
Shock resistance	ΔF/F	5000 g, 0.3 ms, ½ sine	+/-5 ppm
Vibration resistance	ΔF/F	20 g / 10–2000 Hz	+/-5 ppm

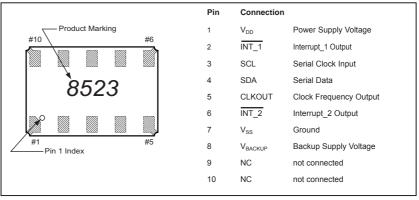
TERMINATIONS AND PROCESSING:

Package-Type	Termination	Processing		
SON 10-pin	For SMD mounting Au plated pads	Reflow soldering 260°C / 20 s max.		

CURRENT CONSUMPTION vs. POWER SUPPLY VOLTAGE:



PIN CONNECTIONS TOP VIEW:



All specifications subject to change without notice.



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